INFORMATION NOTE



N° 089/20

Dear Customer,

With this INFINEON Technologies Information Note we would like to inform you about the following

Harmonization of Step Cut sawing process for IQFN-39 package products assembled at Carsem Sdn. Bhd., Malaysia

Registered Office: Neubiberg Commercial Register: München HRB 126492

INFORMATION NOTE



N° 089/20

Harmonization of Step Cut sawing process for IQFN-39 package products assembled at Carsem Sdn. Bhd., Malaysia

▶ **Products affected:** Please refer to attached affected product list 1_cip08920

Detailed Change Information:

Subject: Harmonization of Step Cut sawing process for IQFN-39 package

products assembled at Carsem Sdn. Bhd., Malaysia

Reason: Harmonization of pre-assembly process to ensure manufacturability

across all assembly sites

Description:

Sawing method : Single cut

Single Cut

Wafer

New

Sawing method : Step cut

Step Cut

Wafer

▶ Product Identification:

Internal traceability via Baunumber, Lotnumber, date code and marking on device

External traceability via marking on device (date code)

► Impact of Change: NO change on electrical and thermal performance

NO impact on the device reliability as proven via product qualification and characterization.

NO impact on the electrical parameters and device processability at customer end.

Initial deliveries will not be affected and longer term supply will be increased, reflected in our future commit levels.

► Attachments: Affected product list 1_cip08920

► Intended start of 07-Sep-2020

delivery:

If you have any questions, please do not hesitate to contact your local Sales office.

AFFECTED MPNS

IR35411MTRPBF

IR35412MTRPBF

TDA21460

TDA21462

TDA21470

TDA21471

TDA21472

TDA21473

TDA21490

TDA21491

SP001665570

SP001665582

SP001579154

SP001645132

SP001579132

SP001579152

SP001645118

SP001645144

SP002504078

SP002594226

IR35411MTRPBFAUMA1

IR35412MTRPBFAUMA1

TDA21460AUMA1

TDA21462AUMA1

TDA21470AUMA1

TDA21471AUMA1

TDA21472AUMA1

TDA21473AUMA1

TDA21490AUMA1

TDA21491AUMA1